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Henning Schröder

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Contents

vii	Authors
ix	Conference Committee

SESSION 1 NOVEL OPTICAL WAVEGUIDE AND INTERCONNECT TECHNOLOGIES

- 9753 02 **GI-core polymer waveguide based on polynorbornene for optical interconnection (Invited Paper) [9753-1]**
- 9753 04 **High-bandwidth and low-loss multimode polymer waveguides and waveguide components for high-speed board-level optical interconnects (Invited Paper) [9753-3]**
- 9753 06 **Comparison of self-written waveguide techniques and bulk index matching for low-loss polymer waveguide interconnects [9753-5]**

SESSION 2 NANOPHOTONICS FOR OPTICAL INTERCONNECTS

- 9753 07 **A chip scale optical Tx/Rx based on silicon photonics from views of multi-mode transmission (Invited Paper) [9753-6]**
- 9753 08 **Silicon photonics for 100 Gbit/s intra-data center optical interconnects (Invited Paper) [9753-7]**
- 9753 09 **Silicon germanium on graded buffer as a new platform for optical interconnects on silicon [9753-8]**
- 9753 0A **Low latency, area, and energy efficient Hybrid Photonic Plasmonic on-chip Interconnects (HyPPI) [9753-9]**
- 9753 0B **An efficient total-internal-reflection optical switch based on reverse breakdown of *pn* junction and thermo-optic effect in silicon [9753-10]**

SESSION 3 HYBRID INTEGRATED OPTICAL LINK MODULES

- 9753 0E **Extended temperature performance of 120 Gbps midboard optical engine [9753-13]**
- 9753 0G **Scalable electro-photonic integration concept based on polymer waveguides [9753-50]**

SESSION 4 ELECTRICAL-OPTICAL PCB TECHNOLOGIES

- 9753 0I **Planar polymer and glass graded index waveguides for data center applications [9753-16]**

9753 0J **Electro-optical circuit board with single-mode glass waveguide optical interconnects** [9753-17]

9753 0K **Assembly and performance of silicone polymer waveguides (Invited Paper)** [9753-18]

SESSION 5 OPTICAL INTERCONNECT DEVICES AND MODULATORS

9753 0M **Light emitters and modulators on SOI for optical interconnects (Invited Paper)** [9753-20]

9753 0P **High quality factor trapezoidal subwavelength grating waveguide micro-ring resonator** [9753-23]

9753 0Q **Miniature mid-infrared thermooptic switch with photonic crystal waveguide based silicon-on-sapphire Mach-Zehnder interferometers** [9753-24]

SESSION 6 FIBER OPTICS AND MICRO-OPTICS INTEGRATION

9753 0R **Multimode and single-mode fibers for data center and high-performance computing applications (Invited Paper)** [9753-25]

9753 0S **Integration of 150 Gbps/fiber optical engines based on multicore fibers and 6-channel VCSELs and PDs** [9753-26]

9753 0T **Analysis of multi-mode to single-mode conversion at 635 nm and 1550 nm** [9753-28]

SESSION 7 OPTICAL INTERCONNECT SYSTEMS

9753 0V **Exabits/s integrated photonic interconnection technology for flexible data-centric optical networks (Invited Paper)** [9753-29]

9753 0W **High-performance flat data center network architecture based on scalable and flow-controlled optical switching system (Invited Paper)** [9753-30]

9753 0Y **Printed polymer photonic devices for optical interconnect systems** [9753-33]

SESSION 8 PICS FOR OPTICAL INTERCONNECTS

9753 10 **SiN-assisted flip-chip adiabatic coupler between SiPh and Glass OPCBs** [9753-35]

9753 11 **Bimorph actuators in thick SiO₂ for photonic alignment** [9753-36]

9753 12 **Experimental study of silicon ring resonators and ultra-low losses waveguides for efficient silicon optical interposers** [9753-38]

9753 13 **Reduced nonlinearities in 100-nm high SOI waveguides** [9753-37]

SESSION 9 HYBRID DEVICE INTEGRATION APPROACHES FOR SILICON PHOTONICS CHIPS

- 9753 15 **Low-power chip-level optical interconnects based on bulk-silicon single-chip photonic transceivers** [9753-40]
- 9753 16 **Characterizations of InAs quantum dot lasers butt-joint coupled with silicon photonics waveguides** [9753-41]
- 9753 17 **Wavelength-controlled external-cavity laser with a silicon photonic crystal resonant reflector** [9753-42]
- 9753 18 **Low-loss curved subwavelength grating waveguide based on index engineering** [9753-43]

POSTER SESSION

- 9753 19 **Suspended mid-infrared fiber-to-chip grating couplers for SiGe waveguides** [9753-44]
- 9753 1A **A new design for coupling light between silicon strip waveguide and plasmonic slot waveguide** [9753-45]
- 9753 1B **SWG-designed MMI waveguides for dual and multi-beam splitting, beam position-shifting, and focusing purposes** [9753-46]
- 9753 1C **High performance Ge-on-Si avalanche photodetector** [9753-47]
- 9753 1D **Composite axilens-axicon diffractive optical elements for generation of ring patterns with high focal depth** [9753-48]
- 9753 1F **Full-mesh optical backplane with standard MM fiber ribbons** [9753-27]

Authors

Numbers in the index correspond to the last two digits of the six-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first four digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

- | | |
|--------------------------------|-------------------------------|
| Abdolahi, Z., 1B | Eichhorn, Catherine M., 0E |
| Al-Saadi, Aws, 08 | El-Ghazawi, Tarek, 0A |
| Apostolopoulos, Dimitrios, 10 | Falcucci, M., 1F |
| Arndt-Staufenbiel, Norbert, 0T | Fan, D. L., 0P, 18 |
| Atif, Muhammad, 08 | Fassi, I., 1F |
| Avramopoulos, Hercules, 10 | Favreau, Julien, 19 |
| Badaway, Abdel-Hameed A., 0A | Fédéli, Jean-Marc, 19 |
| Ballabio, Andrea, 09 | Ferrario, M., 1F |
| Bamiedakis, N., 04 | Fournier, M., 12, 13 |
| Bansal, Lalit, 0S | Fowler, D., 12 |
| Basile, V., 1F | Frey, Christopher, 0J |
| Baskiotis, Catherine, 10 | Frigerio, Jacopo, 09 |
| Baumer, Aaron M., 0E | Gindre, P., 12 |
| Bernabe, S., 12, 13 | Giuliani, G., 13 |
| Bhattacharya, Shanti, 1D | Gonzalez-Fernandez, A. A., 17 |
| Bickham, Scott R., 0R | Grehn, Moritz, 08 |
| Binh, Le Nguyen, 0V | Grellier, E., 12 |
| Blampey, B., 12 | Grüner-Nielsen, Lars, 0S |
| Boersma, A., 0G | Guo, L. Jay, 0Y |
| Boffi, P., 1F | Guo, Wei, 16 |
| Bogatzki, Angelina, 0T | Gustavsson, Johan, 0S |
| Bosman, E., 0G | Hagihara, Yasuhiko, 07 |
| Boutami, Salim, 19 | Håkansson, Andreas, 0J |
| Bronzi, Danilo, 08 | Harmsma, P., 0G |
| Brunner, R., 1D | Hazell, John F., 0E |
| Brusberg, Lars, 0I, 0J, 10 | Heikkilä, Veli, 0S |
| Burrell, Derek, 06 | Henniges, Marvin, 08 |
| Çağrı Ulusoy, Ahmet, 0S | Herbst, Christian, 0J |
| Calabretta, Nicola, 0W | Hodge, Malcolm H., 0K |
| Chaisakul, Papichaya, 09 | Hofmann, Jens, 0T |
| Chakravarty, Swapnajit, 0Q | Horimoto, Akihiro, 02 |
| Chen, J., 04 | Isella, Giovanni, 09 |
| Chen, Ray T., 0P, 0Q, 0Y, 18 | Ishigure, Takaaki, 0I |
| Chung, Chi-Jui, 0Q | Jang, Ki-Seok, 15, 1C |
| Corbett, B., 0G | Jiang, H., 1B |
| Cornelius, Joshua R., 0E | Jin, Muhyun, 0B |
| Coudeville, Jean Rene, 09 | Joo, Jiho, 15, 1C |
| Coviello, D., 1F | Justice, J., 0G |
| Cristiani, I., 13 | Kalavrouziotis, Dimitrios, 10 |
| Daly, A., 0G | Kaminska, B., 1B |
| Dangel, R., 0G | Karppinen, Mikko, 0G, 0S |
| Debnath, Kapil, 17 | Kaynak, Mehmet, 08 |
| Dharmavarapu, Raghu, 1D | Kehayas, Efstratios, 0S |
| Dorren, Harm, 0W | Kim, Gyungock, 15, 1C |
| Dorresteijn, S., 0G | Kim, In Gyoo, 15, 1C |
| Duan, Guang-Hua, 19 | Kim, Jong-Hun, 0B |
| Dubray, O., 12 | Kim, Sanggi, 15 |
| Duis, J., 0G | Kim, Sanghoon, 15, 1C |
| Durantin, Cédric, 19 | Kim, Seong-Hwan, 0B |
| Edmunds, James, 0S | Kim, Sun Ae, 15, 1C |
| Eichhammer, Yann, 0J | King, Roger, 0S |

- Kinoshita, Ryota, 02
 Kissinger, Dietmar, 0S
 Kitazoe, Katsuma, 02
 Ko, Minsu, 0S
 Korhonen, T., 0G
 Kozlovsky, William J., 0E
 Kupijai, Sebastian, 08
 Kurata, Kazuhiko, 07
 Kwack, Myung-Joon, 15
 Lacava, C., 13
 Langsam, David P., 0E
 Larsson, Anders, 0S
 Lee, Chi-Sen, 16
 Lee, Dong-Wook, 0B
 Leinse, Arne, 11
 Lemonnier, O., 12
 Le Roux, Xavier, 09
 Li, Qiaochu, 0Y
 Liles, Alexandros A., 17
 Lischke, Stefan, 08
 Liu, Ruili, 0M
 Lostutter, Calob K., 0K
 Lutz, Sharon M., 0E
 Mai, Andreas, 08
 Manessis, Dionysios, 0J
 Marchetti, R., 13
 Marrapode, Thomas R., 0K
 Marris-Morini, Delphine, 09
 Martinelli, M., 1F
 Meister, Stefan, 08
 Miao, Wang, 0W
 Middlebrook, Christopher, 06
 Minzioni, P., 13
 Mitcheltree, Thomas J., 0E
 Myöhänen, Petri, 0S
 Nakamura, Takahiro, 07
 Narayana, Vikram, 0A
 Neitz, Marcel, 0I, 0J
 Ning, Gordon Liu, 0V
 O'Faolain, Liam, 17
 Offrein, B. J., 0G
 Ogura, Ichiro, 07
 Oh, Jin Hyuk, 15, 1C
 Ollila, Jyrki, 0S
 Oppermann, Hermann, 0J
 Ortsiefer, M., 0G
 Otte, Sven, 08
 Pan, Zeyu, 0Y
 Park, Hyo-Hoon, 0B
 Park, Hyundai, 15
 Park, Jaegyu, 15
 Penty, R. V., 04
 Pernthaler, Dominik, 0J
 Persheyev, Saydulla, 17
 Peters, Tijitte-Jelte, 11
 Pitwon, Richard, 0I
 Postma, Ferry, 11
 Poulopoulos, Giannis, 10
 Prak, Albert, 11
 Preble, Stefan, 16
 Qiu, Ciyan, 0M
 Queisser, Marco, 0J
 Reboud, V., 12
 Renghini, C., 1F
 Rhee, Hanjo, 08
 Richter, Harald H., 08
 Safaisini, Rashid, 0S
 Salminen, Noora, 0S
 Scalmati, Paolo, 1F
 Schild, Beatrice, 0J
 Schröder, Henning, 0I, 0J, 0T, 10
 Schwartz, Erik, 08
 Selicke, David, 08
 Sirbu, Bogdan, 0J
 Sorger, Volker J., 0A
 Stampoulidis, Leontios, 0S
 Stolarek, David, 08
 Su, Yikai, 0M
 Subbaraman, Harish, 0Y
 Sun, Shuai, 0A
 Suzuki, Yasuyuki, 07
 Swatowski, Brandon W., 0K
 Tanskanen, Antti, 0S
 Tao, Thomas Wang, 0V
 Tapaninen, Olli, 0S
 Taunay, Thierry, 0S
 Tekin, Tolga, 0J
 Theiss, Christoph, 08
 Thonnart, Y., 12
 Tichem, Marcel, 11
 Tsang, H. K., 1A
 Vakarin, Vladyslav, 09
 Van Steenberge, G., 0G
 Verdiell, Jean-Marc A., 0E
 Vijayakumar, A., 1D
 Vitali, Marco, 08
 Vitali, V., 13
 Vivien, Laurent, 09
 Wang, Kai, 0I
 Wang, Yaoguo, 0P, 18
 Wang, Zheng, 0P, 18
 Wang, Zihao, 16
 Weber, Daniel, 0J
 Weidner, W. Ken, 0K
 Westbergh, Petter, 0S
 White, I. H., 04
 Wiegersma, S., 0G
 Wöhrmann, Markus, 0J
 Wörhoff, Kerstin, 11
 Worrall, Alex, 0I
 Wu, Kai, 11
 Xu, Xiaochuan, 0P, 18
 Yamauchi, Akira, 0I
 Yao, Ruizhe, 16
 Yashiki, Kenichiro, 07
 Yeo, Sanggu, 0B
 Yoo, Dong-Eun, 0B
 Zamora, Vanessa, 0T
 Zbinden, Eric J., 0E
 Zhang, Cheng, 0Y
 Zhang, Yong, 0M
 Zhu, Bingqing, 1A
 Zimmermann, Lars, 08
 Zou, Yi, 0Q

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- 1 Novel Optical Waveguide and Interconnect Technologies
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- 2 Nanophotonics for Optical Interconnects
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- 3 Hybrid Integrated Optical Link Modules
Alan F. Evans, Corning Incorporated (United States)
- 4 Electrical-Optical PCB Technologies
Marika P. Immonen, TTM Technologies, Inc. (Finland)
- 5 Optical Interconnect Devices and Modulators
Nikos Pleros, Aristotle University of Thessaloniki (Greece)
- 6 Fiber Optics and Micro-Optics Integration
Bill Blubaugh, US Conec Ltd. (United States)
- 7 Optical Interconnect Systems
Richard C. Pitwon, Seagate Systems (UK) Ltd. (United Kingdom)
- 8 PICs for Optical Interconnects
Alan X. Wang, Oregon State University (United States)
- 9 Hybrid Device Integration Approaches for Silicon Photonics Chips
Patrick B. Chu, Sandia National Laboratories (United States)